

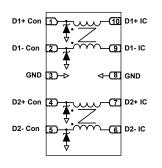
# ECMF04-4HSWM10Y

## Datasheet

## Automotive common mode filter with ESD protection



QFN-10L 2.6 x 1.35 x 0.75



P	roduct status link	
EC	MF04-4HSWM10Y	

Product summary				
Order code	ECMF04-4HSWM10Y			

## **Features**

- AEC-Q101 qualified
- 3.5 GHz differential bandwidth to comply with HDMI 2.0, HDMI 1.4, USB 3.1, MIPI and LVDS
- Common mode attenuation on LTE, GSM, and GPS frequencies:
  - -13 dB at 0.7 GHz
  - -24 dB at 1.5 GHz
  - -30 dB at 2.4 GHZ
  - -26 dB at 2.7 GHZ
  - -16 dB at 5.0 GHZ
- Wettable flank for automatic optical inspection
- Low PCB space consumption: 3.5 mm<sup>2</sup>
- Thin package for compact applications: 0.75 mm
- RoHS package

### Complies with the following standards

• UL94, V0

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- J-STD-020 MSL level 1
- J-STD-002
- IPC7531 footprint and JEDEC registered package
- ISO 10605, IEC 61000-4-2, C = 150 pF R = 330  $\Omega$  level 4:
  - 8 kV (contact discharge)
  - 15 kV (air discharge)
- ISO 10605, C = 330 pF R = 330 Ω level 4:
  - 8 kV (contact discharge)
  - 15 kV (air discharge)

### **Description**

The ECMF04-4HSWM10Y is an integrated common mode filter designed to suppress EMI/RFI common mode noise on high speed buses HDMI 1.4, USB 3.1 and MIPI. It is designed to replace discrete common mode chokes or LTCC.

The device embeds ESD protections on connector side to meets ISO 10605 requirements.

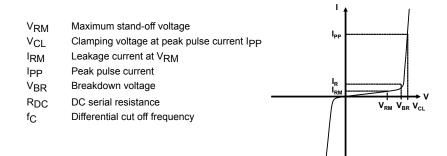
Packaged in QFN-10L with wettable flank, it is compatible with automatic visual inspection.

## 1 Characteristics

Symbol		Value	Unit	
	V <sub>PP</sub> Peak pulse voltage	ISO 10605 (C = 330 pF, R = 330 Ω):		
		Contact discharge	8	kV
\/		Air discharge	15	
VPP		ISO10605 / IEC 61000-4-2 (C = 150 pF, R = 330 Ω):		
		Contact discharge	8	kV
		Air discharge	15	
I <sub>RMS</sub>	RMS current		100	mA
T <sub>op</sub>	Operating ambient temperature range		-55 to +125	°C
T <sub>stg</sub>	Storage temperature range		-55 to +150	

### Table 1. Absolute maximum ratings (T<sub>amb</sub> = 25 °C)

### Figure 1. Electrical characteristics (definitions)

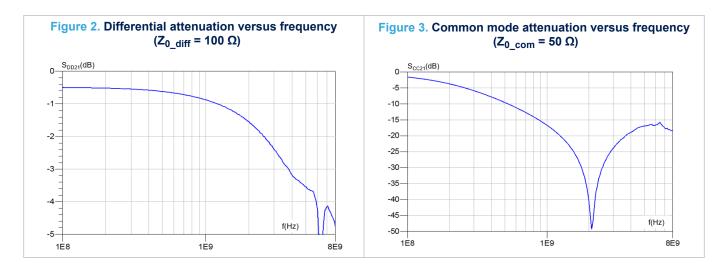


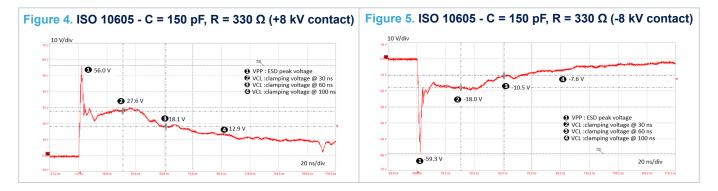
### Table 2. Electrical characteristics (T<sub>amb</sub> = 25 °C)

Symbol	Test conditions	Min.	Тур.	Max.	Unit
V <sub>BR</sub>	I <sub>R</sub> = 1 mA	6	7		V
I <sub>RM</sub>	V <sub>RM</sub> = 3 V			100	nA
R <sub>DC</sub>	I <sub>DC</sub> = 20 mA		5.5		Ω
f <sub>c</sub>	S <sub>DD21</sub> = -3 dB		3.5		GHz
V <sub>CL</sub>	8 kV contact discharge after 30 ns, ISO 10605 (150 pF – 330 $\Omega)$		27		V

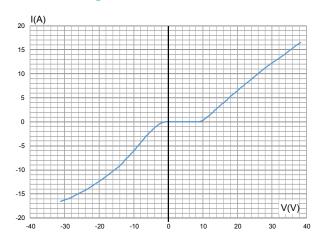
## 1.1 Characteristics (curves)

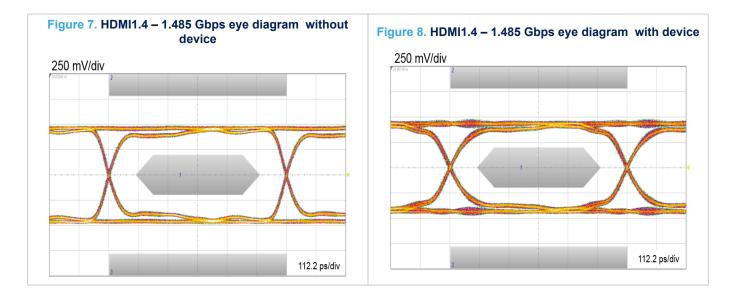
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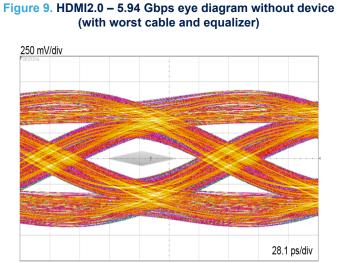




#### Figure 6. TLP characteristic







250 mV/div 28.1 ps/div

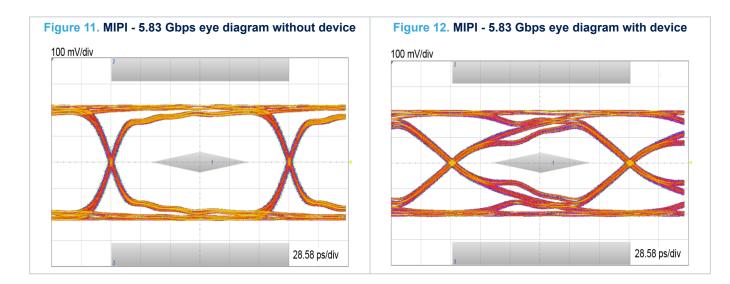
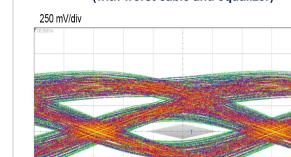
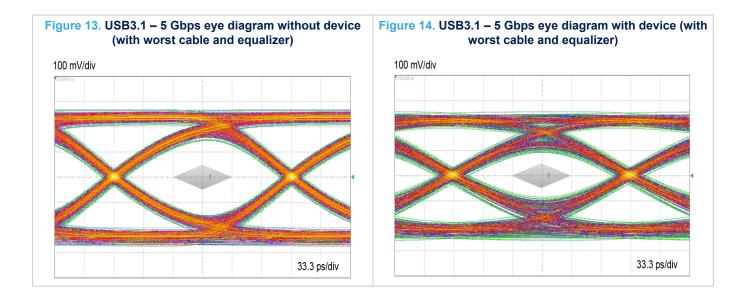


Figure 10. HDMI2.0 – 5.94 Gbps eye diagram with device (with worst cable and equalizer)



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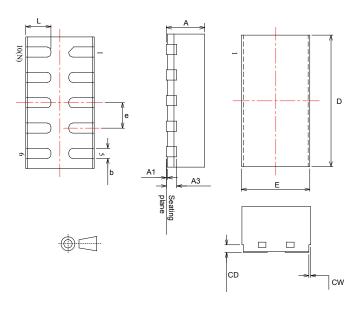




## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

## 2.1 QFN-10L package information



#### Figure 15. QFN-10L package outline

### Table 3. QFN-10L mechanical data

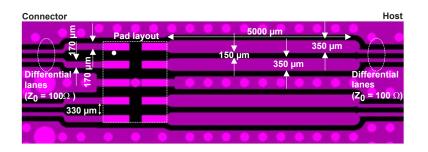
	Dimensions					
Ref.	Millimeters		Inches <sup>(1)</sup>			
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	0.70	0.75	0.80	0.0275	0.0295	0.0315
A1	0.00	0.02	0.05	0.0000	0.0008	0.0020
A3		0.20			0.0079	
b	0.15	0.20	0.25	0.0059	0.0079	0.0099
D	2.55	2.60	2.65	0.1003	0.1024	0.1044
E	1.30	1.35	1.40	0.0511	0.0531	0.0552
е		0.50			0.0197	
L	0.45	0.50	0.55	0.0177	0.0197	0.0217
CW	0.01	0.05	0.09	0.0003	0.0020	0.0032
CD	0.10			0.0039		

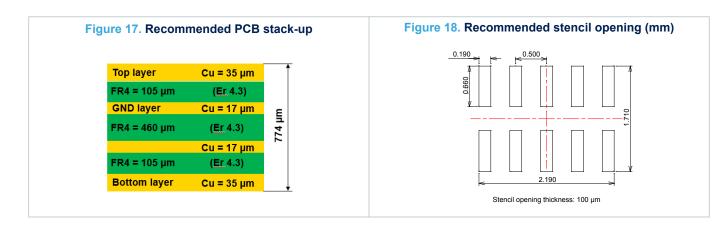
1. Value in inches are converted from mm and rounded to 4 decimal digits



## **3** PCB assembly recommendations

#### Figure 16. Recommended PCB layout





#### Figure 19. Wettable flank profile

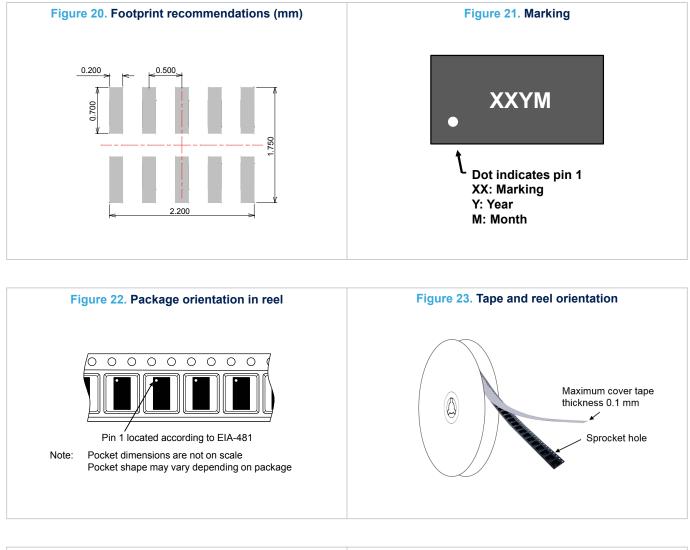


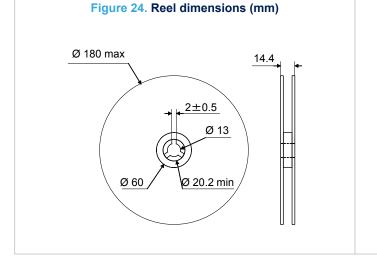
### **3.1 Solder paste**

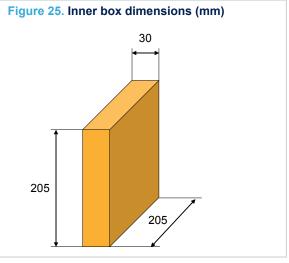
- 1. Halide-free flux qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste is recommended.
- 3. Offers a high tack force to resist component movement during high speed.
- 4. Use solder paste with fine particles: powder particle size is 20-38 µm.



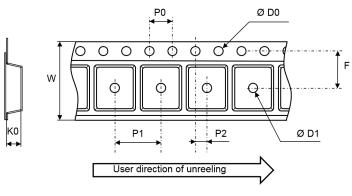
## 3.2 QFN-10L packing information







#### Figure 26. Tape and reel outline



Note: Pocket dimensions are not on scale Pocket shape may vary depending on package

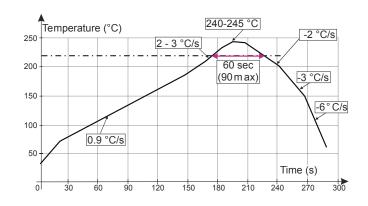
#### Table 4. Tape and reel mechanical data

	Dimensions					
Ref.	Millimeters					
	Min.	Тур.	Max.			
ØD0	1.40	1.50	1.50			
ØD1	0.80					
F	1.65	1.75	1.85			
KO	0.85	0.95	1.05			
P0	3.9	4.0	4.1			
P1	3.9	4.0	4.1			
P2	1.95	2.00	2.05			
W	7.9	8.0	8.3			

### 3.3 Solder reflow

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### Figure 27. ST ECOPACK<sup>®</sup> recommended soldering reflow profile for PCB mounting



*Note:* Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.



# 4 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
ECMF04-4HSWM10Y	BY <sup>(1)</sup>	QFN-10L	7 mg	3000	Tape and reel

1. The marking can be rotated by 90° to differentiate assembly location

## **Revision history**

### Table 5. Document revision history

Date	Version	Changes
17-Dec-2019	1	Initial release.



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